505883762 01/27/2020

EPAS ID: PAT5930587

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHY-JAY LIN	05/31/2018
CHWEN YU	06/19/2018
WILLIAM J. GALLAGHER	06/14/2018

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address: NO 8, LI-HSIN RD. 6, SCIENCE-BASED INDUSTRIAL PARK		
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16743981

CORRESPONDENCE DATA

Fax Number: (202)756-8087

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MCDERMOTT WILL & EMERY LLP **Correspondent Name:** Address Line 1: THE MCDERMOTT BUILDING

Address Line 2: 500 NORTH CAPITOL STREET, N.W.

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	095714-1097
NAME OF SUBMITTER:	TAKASHI SAITO
SIGNATURE:	/Takashi Saito/
DATE SIGNED:	01/27/2020

Total Attachments: 9

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> **PATENT** REEL: 051631 FRAME: 0032 505883762



PATENT REEL: 051631 FRAME: 0033

COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

MAGNET	FIC RANDOM ACCESS MEMORY AND MANUFACTURING METHOD THEREOF
which ap	plication is:
⊠ att	tached, or
	nited States application number or PCT international application number filed on
The above	e-identified application was made or authorized to be made by me.
time I ex authorize associate	ent that the filing date and/or application number are not entered above at the ecute this document, and if such information is deemed necessary, I hereby and request the registered practitioners of McDermott Will & Emery LLP, d with the Customer Number 20277, to insert above the filing date and/or on number of the application.
I hereby punishab years, or l	acknowledge that any willful false statement made in this declaration is le under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) both.

Page 1 of 3

Attorney Docket No. 095714-0507 (P20173191US00)

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. No. 8, Li-Hsin Rd. 6, Science Based Industrial Park, Hsinchu, Taiwan 300

(hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Page 2 of 3

Attorney Docket No. 095714-0507 (P20173191US00)

Legal name of inventor	
Shy-Jay Lin	
Inventor's signature	Date
Sky-Tay fin	Date 5/3//2018
Legal name of inventor	
Chwen Yu	
Inventor's signature	Date
Legal name of inventor	
William J. Gallagher	
	Vana, and the same of the same
Inventor's signature	Date

NP-22652-0-US-B3
Attorney Docket No. 095714-0507 (P20173191US00)

COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

MAGNETIC RANDOM ACCESS MEMORY AND MANUFACTURING METHOD THEREOF

which	application is:	
\boxtimes	attached, or	
	United States application number or PCT international application number filed on	
The al	pove-identified application was made or authorized to be made by me.	
time I author associ	event that the filing date and/or application number are not entered above at the execute this document, and if such information is deemed necessary, I hereby rize and request the registered practitioners of McDermott Will & Emery LLP ated with the Customer Number 20277, to insert above the filing date and/or ation number of the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.		

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I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

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Page 2 of 3

DM_US 89703888-1.095714.0507

Legal name of inventor	
Shy-Jay Lin	
Inventor's signature	Date
Legal name of inventor	
•	
Chwen Yu	
Inventor's signature	Date
Legal name of inventor	
William J. Gallagher	
Inventor's signature	Date
William & Hall les	2018-06-14

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THE PERSON AND THE PE		
application is:		
attached, or		
United States application number or PCT international application numberfiled on		
pove-identified application was made or authorized to be made by me.		
event that the filing date and/or application number are not entered above at the execute this document, and if such information is deemed necessary, I hereby rize and request the registered practitioners of McDermott Will & Emery LLP, ated with the Customer Number 20277, to insert above the filing date and/or ation number of the application.		
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Page 2 of 3

DM_US 89703888-1.095714.0507

TL 2

NP-22652-0-US-B3 Attorney Docket No. 095714-0507 (P20173191US00)

Legal name of inventor	777 R. W.
Shy-Jay Lin	
Inventor's signature	Date
Legal name of inventor	
Chwen Yu	/
Inventor's signature V	Date 06/19/2018
Legal name of inventor	
William J. Gallagher	
Inventor's signature	Date

Page 3 of 3

DM_US 89703888-1.095714.0507

RECORDED: 01/27/2020